1093

Microelectronics Reliability, 7, 1093- (2001)

Pseudopotential study of PrO_2 and HfO_2 in fluorite phase

J. Dąbrowski^{1,a}, V. Zavodinsky^{a,b}, A. Fleszar^c

^aIHP, Im Technologiepark 25, D-15236 Frankfurt(Oder), Germany ^bInstitute for Automation and Control Processes, 5 Radio str., Vladivostok 690041, Russia, ^cWürzburg University, Würzburg, Germany

Abstract

Praseodymium and hafnium oxides are prospective candidates to subsitute SiO_2 in decanano MOSFET transistors. We report first *ab initio* pseudopotential band structure calculations for these materials. We find that fluorite phases of PrO_2 and HfO_2 have similar electronic structures. The important difference is a narrow subband forming the conduction band bottom in PrO_2 but absent in HfO_2 . Electrons in this f-type subband have large masses. This explains why ultrathin epitaxial Pr oxide films have low leakage in spite of a relatively small conduction band offset (~1 eV) between the oxide and the Si substrate.

1 Introduction

Scaling of CMOS [1-4] requires MOSFET gate oxide equivalent thicknesses $t_{eq} < 1.5$ nm for channel lengths below 100 nm. But a 1.5 nm thick SiO₂ is leaky and unreliable. It fails because direct tunneling current depends exponentially on the insulator physical thickness t, determined in turn by scaling rules for gate capacitance C. Since t = K/C, where K is the dielectric constant, one can increase the film thickness n times by replacing SiO_2 by an insulator with K which is n times larger than that of SiO_2 (K of SiO_2 is ~4). This new dielectric should have K above ~ 20 but, for practical reasons [6], lower than ~ 40 . Other key parameters determining the leakage current are: band offsets with respect to Si, and electron and hole effective masses. The purpose of this work is to obtain fundamental data on band structures of important candidates for epitaxial high-K dielectrics: Hf and Pr oxides [5].

These oxides can be produced in a number of

¹Electronic mail: jarek@ihp-ffo.de

crystallographic structures, with unit cells of various shapes. Si(001) substrate imposes symmetry constraints on the epitaxial film (Fig. 1), so that it grows in an orthorombic structure closely related to the fluorite structure. The latter is very simple (Fig. 1, top) and therefore suited for exploratory calculations as those presented here.

We report results for HfO_2 and PrO_2 in the fluorite structure, obtained within the Density Functional Theory (DFT) by the pseudopotential *ab initio* fhi97md package [7]. RPA dielectric function of HfO_2 has been computed from the LDA bands and quasiparticle calculations were done within the GW approximation [12, 13].

2 Computational details

We used the *ab initio* pseudopotential plane wave code fhi97md [7], extended for atoms with valence electrons of f type. We applied Local Density Approximation (LDA) for the exchange and correlation energy [8, 9] and nonlocal pseudopotentials [10, 11]. Most of the results presented



Generic structure of HfO2(110)/Si(001) interface

Figure 1: Si(001) substrate imposes symmetry constraints on the film. Epitaxial praseodymium and hafnium oxide layers (bottom) have structure related to fluorite (top) and a (110) orientation [14, 15].

are obtained with 40 Ry cutoff for plane waves and with two special k-points: (1/4,1/4,1/4) and (3/4,1/4,1/4). Tests have been performed for 10 and 20 k-point schemes and for energy cutoffs between 30 Ry and 60 Ry. We also verifed the influence of a Generalized Gradient Correction [16] and Nonlinear Core Correction [17].

An important part of this work is the construction of a pseudopotential for Pr atoms. The electronic configuration of Pr is $[Xe]4f^35d^06s^2$. We split these electrons into core and valence electrons. As core electrons we take $[Xe]4f^1$, but without 5p electrons which we treat as belonging to the valence group. This procedure is consistent with suggestions to divide the f-electrons of Pr into localized and dellocalized groups [18] and with strong f-d superposition of Pr valence states [18, 19, 20]. The core density of states is computed for a given excited configuration of the valence electrons $4f^x 5p^6 5d^{2-x+y} 6s^{2-y}$ of the free atom and kept frozen during calculations for the solid. The valence electrons are confined to their excited configuration when the pseudopotential is created, but allowed to fully relax in the solid.

We found that reliable pseudopotentials can be obtained with p locality and 0.2 < x < 0.5 and with y=0. Other choices resulted in pseudopo-



Figure 2: Left: Energy cutoff dependence of the band gap of PrO_2 . LDA, 40 Ry, x=0.5. Right: Dependence of LDA band gap on the pseudopotential at 40 Ry.

tentials with ghost states [21] at energies comparable with the conduction band energies of PrO_2 . These ghosts (nonphysical eigenstates) are produced by the specific form of s nonlocality in the pseudopotential. They disappear when the s term is chosen as local. However, s-local pseudopotentials cannot be transferred to the PrO_2 environment: the computed lattice constant a_o of PrO_2 becomes then too large. On the other hand, a_o , obtained with any higher l term chosen as local is about 2% less than experimental, independently of the presence of ghost states above the valence band. Overbinding of this magnitude is typical for LDA. The computed bulk modulus is about 250 GPa, as expected for hard ceramics.

The band structure of PrO_2 depends somewhat on the choice of the pseudopotential (Fig. 2, right), but this dependence is mostly due to relatively rigid shift of the conduction bands. As the valence band and the density of occupied states are only weakly affected, the computed bulk modulus is not strongly affected by the choice of the pseudopotential. Similarly, the main effect of increasing the plane wave cutoff above 40 Ry is a certain reduction of the band gap (Fig. 2, left). Since it is well known that LDA underestimates band gaps (cf. the next Section and Fig. 2, top), we will use the x=0.5 pseudopotential and 40 Ry cutoff, which produce the widest band gap among the pseudopotentials free from ghost states.

3 Discussion of results

This Section compares *ab initio* electronic structures computed for HfO_2 and PrO_2 . First, we consider DFT (LDA) and quasiparticle-corrected



Figure 3: Band structures of Hf and Pr dioxide, fluorite phase. Energy zero is at top of the valence band. Top: HfO_2 computed with LDA (solid lines) and true excitation energies obtained with GW (circles). LDA yields a good valence band and a principially correct structure of the conduction band, but the gap width is underestimated. Mid: PrO₂ computed with no f states; essentially the same as HfO_2 . Bottom: PrO₂ computed with f states; a narrow f-band is formed at the CB bottom.

(GW) band structures of HfO_2 . In contrast to DFT, which is designed to yield the correct electron density and total energy of the electronic ground state, the quasiparticle correction formalism aims for realistic electronic excitation energies. Second, we compute LDA band structures of PrO_2 with and without the contribution from f electrons and discuss differences to the HfO_2 case. Third, we address implications for the gate leakage currents of transistors with gate dielectrics containing high Pr concentration. Finally, we mention the effect of pressure on PrO_2 band gap.

An interesting feature of the electronic structure of HfO_2 (Fig. 3, top) is that the valence band (VB) top is displaced from the Brillouin zone (BZ) center towards the BZ edge at X. This result is independent of the choice of pseudopotentials and of numerical conditions (plane wave basis set, BZ sampling scheme) and is seen also in GW excitation energies. We obtain a direct band gap close to X; its width is about 3.5 eV in LDA. Quasiparticle correction (GW) opens the forbidden gap to nearly 5.5 eV and changes some distances between the conduction band (CB) states, but the overall CB structure remains the same as in LDA. The VB structure is much less affected.

The LDA band structure of PrO_2 computed with neglect of Pr f electrons (Fig. 3, mid) resembles that of HfO_2 . The main difference is that the VB top becomes flatter, resulting in increased hole effective mases. Inclusion of f electrons (Fig. 3, bottom) leads to narrowing of the VB and to more pronounced maxima in the VB top. They remain outside the BZ center but are located further away from the BZ edge than for HfO_2 .

But the most important effect is the appearance of a narrow subband under the CB bottom. This band is responsible for a much smaller forbidden gap in PrO_2 when compared to that of HfO_2 . It is built mostly of *f*-states of Pr atoms and is rather narrow, that is, quite localized.

Does this *f*-band remain at the CB bottom also in the guasiparticle spectrum, i.e., in the real spectrum of electronic excitation energies? We are not yet able to answer this question by a GW calculation. But we performed a simple estimate of the contribution to the difference between the true excitation energy and the LDA eigenvalue from the LDA self-interaction term. This contribution can be large because the band is quite localized. To estimate the correction, we computed the band structure of a degenerate material with one conduction electron per unit cell. The f states did move close to the rest of the CB, but still forming a separate band below these other states. Therefore, we have reasons to believe that the CB bottom of PrO_2 is indeed built of f states.

This result has a consequence for our understanding of leakage currents through some transition metal oxide dielectrics. Note that the band gap of a lanthanide row (i.e., *f*-electron) transition metal oxide (PrO₂) is considerably smaller than that of a *d*-electron transition metal oxide (HfO₂) where *f* electrons play little role. Recent experiments [22] indicate that the actual band gap of a Pr₂O₃/Si(001) film (which has an atomic

structure similar to that of PrO₂) is only 2-3 eV. But from the point of view of the tunneling current, this narrowing of the band gap and, most probably, the corresponding reduction of the CB offset with respect to silicon, is compenstated by large electron masses in the oxide CB.

Finally, we note that the results reported here have been obtained for bulk material. An epitaxial film is under high strain caused by lattice mismatch to the substrate. We have not yet computed the influence of the epitaxial, lateral stress on the electronic structure of the oxide. But we observed that the influence of hydrostatic stress on PrO_2 band gap is not dramatic: when the lattice constant is varied from 5.1 to 5.5 Angstroms, the band gap decreases only by 0.4 eV. This means that a lateral stress of the magnitude of a few percents would induce changes in the band gap of the order of 0.1 eV. In our opinion, this result indicates that our conclusions remain valid also for epitaxial material.

4 Summary and conclusions

We reported results of *ab initio* calculations for fundamental electronic properties of HfO_2 and PrO_2 in their fluorite-structure phases, i.e., those related to films grown epitaxially on silicon substrates. We described a method to construct a working pseudopotential for Pr and presented results of first pseudopotential *ab initio* DFT-LDA calculations for the electronic structure of bulk PrO_2 . We compared them to LDA and first GW electronic structures of HfO₂.

We found that both materials have a rather similar band structure, with exception of a narrow f-band which forms the bottom of the conduction band in PrO_2 but is missing in HfO₂. This f-band is responsible for low leakage of Pr oxide gate dielectrics in spite of relatively small band gap of this material.

Acknowledgments

We are grateful to John von Neumann Institute for Computing for a grant of Cray time (Project "Atomic-scale simulation of transition-metal oxides for CMOS technology development"), to R. Casali for collaboration in the initial phase of generation and testing of Pr pseudopotentials, to M. Caravaca for discussions on atomic structures of HfO_2 , and to H. J. Osten for encouragement and reading of the manuscript.

References

- ¹ S. M. Sze. Physics of Semiconductor Devices. Wiley, 1981.
- ² L. Manchanda. In: W. M. Bullis, D. G. Seiler, and A. C. Diebold (Eds.) Semiconductor Characterization. Woodbury, New York 1996, p. 123.
- ³ J. Dabrowski, H.-J. Müssig, M. Duane, S. T. Dunham, R. Goossens, H.-H. Vuong. Advances in Solid State Physics 38 (1999) 565. Postscript file available from www.ihp-ffo.de/chipps/97/Ddoc/dpg.html
- ⁴ J. Dabrowski, H.-J. Müssig. Silicon Surfaces and Formation of Interfaces. World Scientific, Singapore, 2000; see www.ihp-ffo.de/chipps/Dbook2000
- ⁵ H. J. Osten, J. P. Liu, P. Gaworzewski, E. Bugiel, and P. Zaumseil, Techn. Dig. IEDM 2000.
- ⁶ B. Cheng, M. Cao, R. Rao, A. Inani, P. Vande Voorde, W. M. Greene, J. M. C. Stork, Z. Yu, P. M. Zeitzoff, and J. C. S. Woo. IEEE Transactions on Electron Devices 46 (1999) 1537.
- ⁷ M. Bockstedte. Comp. Phys. Commun. 107 (1997) 187.
 ⁸ D. M. Ceperley, B. J. Alder. Phys. Rev. Lett. 45 (1980) 567.
- ⁹ J. P. Perdew, A. Zunger. Phys. Rev. B. 23 (1981) 5048.
- ¹⁰ D. R. Hamann. Phys. Rev. B 40 (1989) 2980; G. B. Bachelet, D. R. Hamann, M. A. Schlüter. Phys. Rev. B 26 (1982) 4199.
- ¹¹ L. Kleinman, D. M. Bylander. Phys. Rev. Lett. 48 (1982) 1425.
- ¹² L. Hedin, S. Lundqvist. In: H. Ehrenreich, F. Seitz, D. Turnbull (Eds.) Solid State Physics. Academic, New York, 1969, Vol. 23, p. 1;W. G. Aulbur, L. Jonsson, J. W. Wilkins. H.Ehrenreich, F. Spaepen (Eds.) Solid State Physics, Academic, New York, 2000, Vol. 54, p. 1.
- ¹³ A.Fleszar, W.Hanke. Phys. Rev. B 56 (1997) 10228.
- ¹⁴ H. J. Osten, J. P. Liu, E. Bugiel, and P. Zaumseil, sobmitted to Phys. Rev. Lett.
- ¹⁵ J. Dabrowski and V. Zavodinsky, unpublished.
- ¹⁶ J. P. Perdew, K. Burke, and Y. Wang. Phys. Rev. B 54 (1996) 16533.
- ¹⁷ S. G. Louie, S. Froyen, and M. L. Cohen. Phys. Rev. B 26 (1982) 1738.
- ¹⁸ U. Lundin, I. Sandalov, O. Eriksson, B. Johansson. Physica B 259-261 (1999) 231.
- ¹⁹ P. K. De Molle, S. K. Sinharoy. Phys. Lett. A 249 (1998) 147.
- ²⁰ C. Hwang, J. W. Lee, S. T. Kim, B. H. Lee, and M. Onellion. Solid State Comm. 103 (1997) 229.
- ²¹ X. Gonze, R. Stumpf, and M. Scheffler. Phys. Rev. B 44 (1991) 8503.
- ²² J. P. Liu and H. J. Osten, unpublished.